F75P - 3U CompactPCI® PlusIO Safe Railway Computer



The F75P is a COTS computer with onboard functional safety that unites three CPUs on one 3U CompactPCI® PlusIO card. It makes Intel® Atom™ E6xx performance with dual redundancy extremely compact, mainly targeting railway applications. Two independent Control Processors (CP) with independent DDR2 RAM and Flash and a supervision structure provide safety: with redundant software running on F75P, and with the software instances on the two CPs comparing their output, the board becomes a fail-silent subsystem, i.e. it can shut down in case of a fatal fault. Its I/O Processor (IOP) is built up like a classic CompactPCI® CPU board, including DDR2 RAM, front and rear I/O. The front connectors include VGA, two USB 2.0, and two 100-Mbit (Fast) Ethernet channels. At the rear, the board provides another four USB 2.0, two Fast Ethernet ports, one 3-Gbit SATA and one PCI Express® x1 link. These interfaces comply with the standardized pinout of CompactPCI® PlusIO (PICMG 2.30). An onboard mSATA slot makes for scalable, robust mass storage. The intelligent board management controller of the IOP logs events such as reset, overvoltage or undervoltage in a nonvolatile FRAM.

The Control (CP) and I/O Processors (IOP) communicate via internal Ethernet links provided by an FPGA. While the IOP also supports Windows®, the CPs are designed to run a deterministic real-time operating system such

- 2x Intel® Atom™ E6xx, 512 MB DDR2 RAM (each) for onboard dual redundancy
- 1x Intel® Atom™ E6xx, 1 GB DDR2 for I/O
- Independent supervisors for each block
- Fail-safe and fail-silent board architecture
- Clustering of two F75P to raise availability
- Event logging
- Certifiable up to SIL 4 (with report from TÜV SÜD)
- Developed according to EN 50129 and IEC 61508
- Full EN 50155 compliance
- -40 to +85°C qualified
- Conformal coating

as VxWorks® or PikeOS. It is also possible to implement diversitary software on both kernels. All three CPUs support Linux and VxWorks®.

The F75P can replace multiprocessing systems with CPU redundancy and I/O by a small-footprint, low-power solution that is flexible for different types of application scenarios. It uses a single +5V supply voltage to allow operation with external power supplies that do not generate +3.3 V.

A clustering option is considered as well, to increase system availability: two F75P boards can operate next to each other, and can provide hot or cold stand-by. F75P-based systems are generally certifiable up to SIL 4. Since the card has no voter of its own, the software that implements and controls functional safety behavior has to be added by the customer. The safety features such as the CP supervisors are designed to SIL 4 according to EN 50129. The board comes with the "safety case" document and a certificate from TÜV SÜD.

Its rugged set-up also make the F75P truly rail-ready: with assets like conformal coating and an operating temperature of -40 to +85°C with qualified components, it is fully EN 50155 compliant. A 4-HP version is available with RJ45 Ethernet connectors and a reduced temperature range for system design, while another standard card with 8 HP width provides the necessary space for M12 front connectors and a larger heat sink for -40 to +85°C.



Technical Data

CPUs

- Three onboard processors
 - ☐ Two Control Processors (CP)
 - □ One I/O Processor (IOP)
- Intel® Atom™ E6xx Series
 - □ 0.6 GHz to 1.6 GHz processor core frequency
 - □ Three identical processors
 - Please see Standard Configurations and Options below for options and available standard versions.
- Chipset
 - □ Intel® EG20T Platform Controller Hub (PCH)
 - □ Implemented only once for I/O Processor

Memory

- 512 KB L2 cache integrated in E6xx for each processor
- Up to 1 GB SDRAM system memory to each of the Control Processors (CP)
 - Soldered
 - □ DDR2
 - □ 800 MHz memory bus frequency (800 MT/s data rate)
- Up to 2 GB SDRAM system memory to I/O Processor (IOP)
- Soldered
- □ DDR2
- □ 800 MHz memory bus frequency (800 MT/s data rate)
- 2 MB BIOS Flash
- 8 KB non-volatile FRAM connected to IOP for event logging
- mSATA disk slot
 - □ Connected via one SATA channel
- Please see Standard Configurations and Options below for options and available standard versions.

Mass Storage

- Serial ATA (SATA)
 - □ One port for mSATA onboard devices
 - □ One port for rear I/O
 - □ SATA Revision 2.x support
 - □ Transfer rates up to 300 MB/s (3 Gbit/s)

Graphics

- Integrated in E6xx processor
 - 320 or 400 MHz graphics base frequency, depending on processor type
 - □ Maximum resolution: 1280 x 1024 pixels
- VGA connector at front panel

I/O

- USB
 - □ Six USB 2.0 host ports
 - ☐ Two Series A connectors at front panel
 - □ Four ports via rear I/O on CompactPCI® J2
 - □ OHCI and EHCI implementation
 - □ Data rates up to 480 Mbit/s

- Fthernet
 - □ Four 10/100Base-T Ethernet channels
 - Two channels via RJ45 or M12 connectors at front panel, with status LEDs
 - □ Two channels via rear I/O on CompactPCI® J2
- PCI Express®
 - □ One PCI Express® x1 link via rear I/O on CompactPCI® |2
 - □ PCle® 1.0a support
 - □ Data rate up to 250 MB/s in each direction (2.5 Gbit/s per lane)

Front Connections (Standard)

- VGA
- Two USB 2.0 (Series A)
- Two 10/100Base-T Ethernet (RJ45 or M12)

Rear I/O (PICMG 2.30)

- One SATA (3 Gb)
- Four USB 2.0
- Two 10/100Base-T Ethernet
- One PCI Express® x1 link
- Compatible with PICMG 2.30 CompactPCI® PlusIO
 - □ 1PCI33/1PCIE2.5/1SATA3/4USB2/2ETH100
 - Some pins are used for signals differing from the PICMG 2.30 specification, e.g., for clustering.
 However, these signals do not destroy or cause any malfunction of a connected I/O board based on this standard.

Event Logging

- Event history logged in non-volatile FRAM, e.g., reset, overvoltage, undervoltage, excess temperature
- 256 entries possible
- Events are generated by board hardware or user application

Cluster Link

- Two F75P boards can be connected to form a cluster
- Cluster link interface based on RS422
 - □ Accessible on CompactPCI® J2 rear I/O connector
 - □ Bidirectional, full-duplex, differential interface

Miscellaneous

- Real-time clock with supercapacitor backup connected to I/O Processor
- Three independent supervisors for Control Processors and Inter-Communication FPGA
 - Check for overvoltage, undervoltage, excess temperature, internal errors of FPGA and CPUs, CPU und FPGA clock
 - □ Perform a range of self tests
- Watchdog
- Board Management Controller for I/O Processor



Technical Data

- Status LED at front panel
- Reset button at front panel

CompactPCI® Bus

- Compliance with CompactPCI® Core Specification PICMG 2.0 R3.0
- System slot
- 32-bit/33-MHz PCI-to-PCI bridge
- V(I/O): +3.3 V (+5 V tolerant)
- Hot insertion and removal without damage

Busless Operation

- Board can be supplied with +5 V only, all other voltages are generated on the board
- Backplane connectors used only for power supply

Electrical Specifications

- Supply voltage/power consumption:
 - □ +5 V (-5%/+5%), tbd. A

Mechanical Specifications

- Dimensions: conforming to CompactPCI® specification for 3U boards
- Front panel: 4 HP or 8 HP with ejector
- Weight: tbd. g (incl. heat sink)

Environmental Specifications

- Temperature range (operation):
 - □ -40..+50°C in 4 HP version (qualified components)
 - -40..+85°C in 8 HP version (qualified components), compliant with EN 50155, class Tx
 - Conditions: airflow 1.5 m/s, typical power dissipation: tbd.
- Temperature range (storage): -40..+85°C
- Relative humidity (operation): max. 95% non-condensing
- Relative humidity (storage): max. 95% non-condensing
- Altitude: -300 m to +3000 m
- Vibration (function): 1 m/s², 5 Hz 150 Hz (EN 50155 (12.2.11) / EN 61373)
- Vibration (lifetime): 7.9 m/s², 5 Hz 150 Hz (EN 50155 (12.2.11) / EN 61373)
- Shock: 50 m/s², 30 ms (EN 50155 (12.2.11) / EN 61373)
- Conformal coating (standard)

МТВІ

■ tbd. h @ 40°C according to IEC/TR 62380 (RDF 2000)

Safety

- Functional Safety
 - □ Certifiable up to SIL 4 according to EN 50129 ("safety case" document and certificate from TÜV SÜD available)
 - □ Hazard rate for safety functions <= 1E-9 / h

- Configured for deterministic behavior, e.g.,
 Hyper-Threading disabled, speed-step disabled, BIOS interrupts disabled
- Board maintains safe state after a failure (factory configuration)
- Flammability
 - PCB manufactured with a flammability rating of 94V-0 by UL recognized manufacturers

EMC Conformity

- When integrated into an EMC protected rack
- EN 50121-3-2 (tables 5 and 6) / EN 55011 (radio disturbance)
- EN 50121-3-2 (table 9) / IEC 61000-4-6 (ESD)
- EN 50121-3-2 (table 9) / IEC 61000-4-3 (electromagnetic field immunity)
- EN 50121-3-2 (table 8) / IEC 61000-4-4 (burst)
- EN 50121-3-2 (table 8) / IEC 61000-4-6 (conducted disturbances)

BIOS

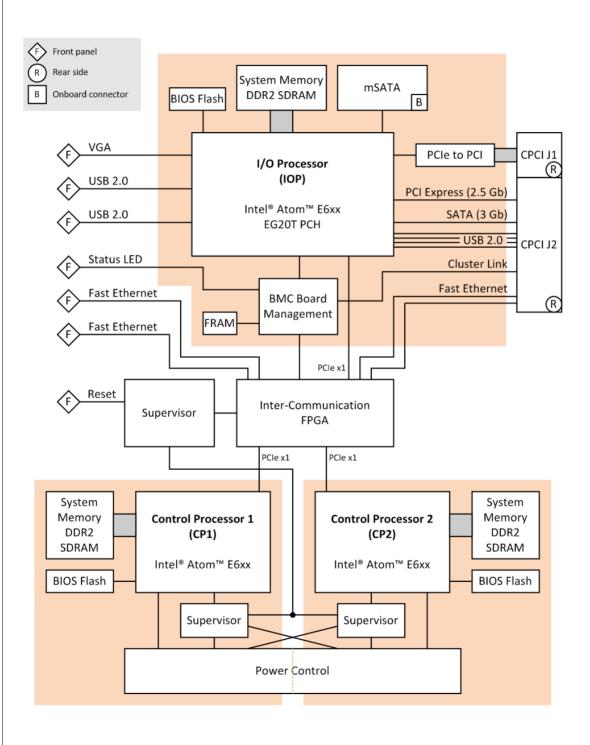
■ InsydeH2OTM UEFI Framework

Software Support

- I/O Processor
 - □ Windows® 7
 - □ Windows® Embedded Standard 7 (in preparation)
 - □ Linux (in preparation)
 - □ VxWorks® (on request)
- Control Processors
 - □ Linux (in preparation)
 - □ VxWorks® (in preparation)
 - □ VxWorks®/Cert (on request)
 - □ PikeOS (in preparation)
- For more information on supported operating system versions and drivers see Software.



Diagram





Configuration & Options

Standard Configurations

Article No.	СРИ Туре	System RAM	Ethernet connectors	Front Panel	Conformal Coating	Operating Temperature
02F075P00	3x E680T, 1.6 GHz	CPs: 512 MB each, IOP: 1 GB	RJ45	4 HP	Yes	-40+50°C qualified
02F075P01	3x E680T, 1.6 GHz	CPs: 512 MB each, IOP: 1 GB	M12 (right)	8 HP	Yes	-40+85°C qualified

Options

CPU

- Intel® Atom™ E620T, 0.6 GHz, 320 MHz graphics frequency, 3.3 W TDP (estimated)
- Intel® Atom™ E640T, 1.1 GHz, 320 MHz graphics frequency, 3.6 W TDP
- Intel® Atom™ E660T, 1.3 GHz, 400 MHz graphics frequency, 3.6 W TDP
- Intel® Atom™ E680T, 1.6 GHz, 400 MHz graphics frequency, 4.5 W TDP (estimated)

Memory

- System RAM
 - □ 512 MB or 1 GB for each Control Processor
 - □ 1 GB or 2 GB for I/O Processor
- mSATA disk
 - □ 0 MB up to maximum available

1/0

- Ethernet
 - □ RJ45 or M12 connectors
 - M12 connectors need a second front-panel slot (8 HP total width) and can be placed to the left or right side of the CPU PCB.

Operating Temperature

- -40..+50°C (4 HP)
- -40..+85°C (8 HP, with larger heat sink)
- Depends on heat sink configuration

Coating

With or without conformal coating

Cooling Concept

Also available with conduction cooling in MEN CCA frame

Restart Option

 Board can be configured to restart automatically after entering safe state (by factory configuration)

Software Support

- VxWorks® for I/O Processor (on request)
- VxWorks®/Cert for Control Processors (on request)

Please note that some of these options may only be available for large volumes. Please ask our sales staff for more information.



Ordering Information

Standard F75P Models

02F075P00 F75P, 3U CompactPCI® (PICMG 2.0) and

> CompactPCI® PlusIO (PICMG 2.30) SBC, 3x Intel® Atom™ E680T (1.6 GHz), 2x 512 MB, 1x 1 GB DDR2 DRAM, 4 HP, -40..+50°C qualified

02F075P01 F75P, 3U CompactPCI® (PICMG 2.0) and

> CompactPCI® PlusIO (PICMG 2.30) SBC, 3x Intel® Atom™ E680T (1.6 GHz), 2x 512 MB, 1x 1 GB DDR2 DRAM, 8 HP, Ethernet on the right

by 2x M12, -40..+85°C qualified

Related Hardware

08CT12-00 CompactPCI® PlusIO rear transition module

3U/80mm, 2 Ethernet, 4 USB, 4 SATA, 4 PCIe®

x1, -40°C..+85°C qualified

Memory

0751-0051 SSD mSATA, 8 GB, -40..+85°C

Systems & Card Cages

0701-0046 CompactPCI® 19" 4U/24HP desktop system for

> 3U cards, 3-slot 3U CompactPCI® backplane, system slot right, 1U fan tray with 1 fan,

8 HP space for 1 pluggable PSU

0701-0056 CompactPCI® 19" 4U/84HP rack-mount

enclosure for 3U cards (vertical), 4+4-slot 3U CompactPCI® / CompactPCI® Serial hybrid backplane, prepared for rear I/O, 250W power supply wide range 90..264VAC on rear, 1U fan tray with 2 fans included, 0..+60°C

Documentation

Compare 3U CompactPCI® Serial CPU and I/O cards

For the most up-to-date ordering information and direct links to other data sheets and downloads, see the F75P online data sheet under » www.men.de.



Contact Information

Germany

MEN Mikro Elektronik GmbH Neuwieder Straße 3-7 90411 Nuremberg Phone +49-911-99 33 5-0 Fax +49-911-99 33 5-901 E-mail info@men.de www.men.de

France

MEN Mikro Elektronik SA 18, rue René Cassin ZA de la Châtelaine 74240 Gaillard Phone +33 (0) 450-955-312 Fax +33 (0) 450-955-211 E-mail info@men-france.fr

USA

MEN Micro, Inc. 24 North Main Street Ambler, PA 19002 Phone (215) 542-9575 Fax (215) 542-9577 E-mail sales@menmicro.com

> mikro elektronik gmbh · nürnberg

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